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RELIABILITY REPORT
FOR
MAX9673ETI+T
PLASTIC ENCAPSULATED DEVICES

April 1, 2012

MAXIM INTEGRATED PRODUCTS

120 SAN GABRIEL DR.
SUNNYVALE, CA 94086

Approved by
Richard Aburano
Quality Assurance
Manager, Reliability Engineering

Conclusion

The MAX9673ETI+T successfully meets the quality and reliability standards required of all Maxim products. In addition, Maxim's continuous reliability monitoring program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards.

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I. Device Description

A. General

The MAX9672/MAX9673/MAX9674 output 12/14/16 voltage references for gamma correction in TFT LCDs and one voltage reference for VCOM. Each gamma reference voltage has its own 10-bit DAC and buffer to ensure a stable voltage. The VCOM reference voltage has its own 10-bit DAC and an amplifier to ensure a stable voltage when critical levels and patterns are displayed. The MAX9672/MAX9673/MAX9674 feature integrated multiple-time programmable (MTP) memory to store gamma and VCOM values on the chip, eliminating the need for external EEPROM. The MAX9672/MAX9673/MAX9674 support up to 300 write operations to the on-chip nonvolatile memory. The gamma outputs can drive 200mA peak transient current and settle within 1 μ s. The VCOM output can provide 600mA peak transient current and also settles within 1 μ s. The analog supply voltage range extends from 9V to 20V, and the digital supply voltage range extends from 2.7V to 3.6V. Gamma values and the VCOM value are programmed into registers through the I²C interface.

II. Manufacturing Information

A. Description/Function:	10-Bit, Programmable Gamma Reference Systems with MTP for TFT LCDs
B. Process:	S45
C. Number of Device Transistors:	4548
D. Fabrication Location:	USA
E. Assembly Location:	China, Taiwan and Thailand
F. Date of Initial Production:	July 25, 2009

III. Packaging Information

A. Package Type:	28-pin TQFN 5x5
B. Lead Frame:	Copper
C. Lead Finish:	100% matte Tin
D. Die Attach:	Conductive
E. Bondwire:	Au (1 mil dia.)
F. Mold Material:	Epoxy with silica filler
G. Assembly Diagram:	#05-9000-3809
H. Flammability Rating:	Class UL94-V0
I. Classification of Moisture Sensitivity per JEDEC standard J-STD-020-C	Level 1
J. Single Layer Theta Ja:	47°C/W
K. Single Layer Theta Jc:	2°C/W
L. Multi Layer Theta Ja:	29°C/W
M. Multi Layer Theta Jc:	2°C/W

IV. Die Information

A. Dimensions:	99 X 101 mils
B. Passivation:	Si ₃ N ₄ /SiO ₂ (Silicon nitride/ Silicon dioxide)
C. Interconnect:	Al/0.5%Cu with Ti/TiN Barrier
D. Backside Metallization:	None
E. Minimum Metal Width:	Metal1 = 0.5 / Metal2 = 0.6 / Metal3 = 0.6 microns (as drawn)
F. Minimum Metal Spacing:	Metal1 = 0.45 / Metal2 = 0.5 / Metal3 = 0.6 microns (as drawn)
G. Bondpad Dimensions:	
H. Isolation Dielectric:	SiO ₂
I. Die Separation Method:	Wafer Saw

V. Quality Assurance Information

- A. Quality Assurance Contacts: Richard Aburano (Manager, Reliability Engineering)
Don Lipps (Manager, Reliability Engineering)
Bryan Preeshl (Vice President of QA)
- B. Outgoing Inspection Level: 0.1% for all electrical parameters guaranteed by the Datasheet.
0.1% For all Visual Defects.
- C. Observed Outgoing Defect Rate: < 50 ppm
- D. Sampling Plan: Mil-Std-105D

VI. Reliability Evaluation

A. Accelerated Life Test

The results of the 135C biased (static) life test are shown in Table 1. Using these results, the Failure Rate (λ) is calculated as follows:

$$\lambda = \frac{1}{\text{MTTF}} = \frac{1.83}{192 \times 4340 \times 48 \times 2} \text{ (Chi square value for MTTF upper limit)}$$

(where 4340 = Temperature Acceleration factor assuming an activation energy of 0.8eV)

$$\lambda = 22.9 \times 10^{-9}$$

$$\lambda = 22.9 \text{ F.I.T. (60\% confidence level @ 25°C)}$$

The following failure rate represents data collected from Maxim's reliability monitor program. Maxim performs quarterly life test monitors on its processes. This data is published in the Reliability Report found at <http://www.maxim-ic.com/qa/reliability/monitor>. Cumulative monitor data for the S45 Process results in a FIT Rate of 0.06 @ 25C and 1.00 @ 55C (0.8 eV, 60% UCL)

B. E.S.D. and Latch-Up Testing

The DV26 die type has been found to have all pins able to withstand a transient pulse of:

- ESD-HBM: +/- 2500V per JEDEC JESD22-A114 (lot TYXZAQ001E, D/C 0924)
- ESD-CDM: +/- 750V per JEDEC JESD22-C101 (lot TYXZAQ001E, D/C 0924)
- ESD-MM: +/- 250V per JEDEC JESD22-A115 (lot TYXZAQ001B, D/C 0924)

Latch-Up testing has shown that this device withstands a current of +/- 250mA and overvoltage per JEDEC JESD78 (lot TYXZAQ001D, D/C 0924).

Table 1
Reliability Evaluation Test Results

MAX9673ETI+T

TEST ITEM	TEST CONDITION	FAILURE IDENTIFICATION	SAMPLE SIZE	NUMBER OF FAILURES	COMMENTS
Static Life Test (Note 1)	Ta = 135C Biased Time = 192 hrs.	DC Parameters & functionality	48	0	TYXZAQ001C, D/C 0923

Note 1: Life Test Data may represent plastic DIP qualification lots.